

Hyper SuperServer SYS-621H-TN12R



2U Hyper with 12 hot-swap 3.5" NVMe/SAS/SATA bays and 4 PCIe 5.0 x16 slots + up to 2 PCIe 5.0 x16 AIOM slots

Key Applications

Virtualization, Software-defined Storage, Al Inference and Machine Learning, Cloud Computing, Enterprise Server,

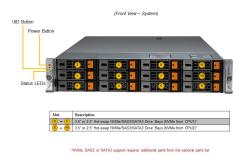
Key Features

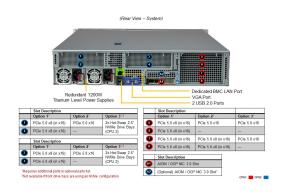
- Dual Socket E (LGA-4677) 5th/4th Gen Intel® Xeon® Scalable processors;
- 32 DIMM slots supporting up to 8TB of memory; RDIMMs up to DDR5-5600;
- Optional PCIe slot configurations up to 8 PCIe 5.0 x8 or 4 PCIe 5.0 x16 slots with support for double-width GPU/Accelerator cards;
- Flexible networking options with up to 2 AIOM networking slots (OCP NIC 3.0 compatible);
- 4 heavy duty hot-swap fans with optimal fan speed control;



Form Factor	2U Rackmount Enclosure: 437 x 88.9 x 803mm (17.2" x 3.5" x 31.6")
	Package: 605 x 263 x 1107mm (23.8" x 10.4" x 43.6")
Processor	Dual Socket E (LGA-4677)
	5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable processors
	Supports Intel Xeon CPU Max Series with high bandwidth memory (HBM)
	Up to 64C/128T; Up to 320MB Cache per CPU
GPU	Max GPU Count: Up to 4 double-width or 4 single-width GPU(s)
	Supported GPU: NVIDIA PCIe: H100, L40S, A40, A100
	CPU-GPU Interconnect: PCIe 5.0 x16 CPU-to-GPU Interconnect
	GPU-GPU Interconnect: PCIe
System Memory	Slot Count: 32 DIMM slots
	Max Memory (1DPC): Up to 4TB 5600MT/s ECC DDR5 RDIMM
	Max Memory (2DPC): Up to 8TB 4400MT/s ECC DDR5 RDIMM
Drive Bays Configuration	Default: Total 12 bay(s)
	• 12 front hot-swap 3.5" NVMe*/SAS*/SATA* drive bay(s)
	(*NVMe/SAS/SATA support may require additional storage controller and/or cables, please see the optional parts
	list for details)
	M.2: 2 M.2 NVMe/SATA slot(s) (M-key 2280/22110)
Expansion Slots	PCI-Express (PCIe) Configuration: Option A*
	 4 PCIe 5.0 x16 (in x16) FH/10.5"L double-width slot(s)
	 2 PCIe 5.0 x16 AIOM slot(s) (OCP 3.0 compatible)
	Option B*
	• 8 PCIe 5.0 x8 (in x16) HH/10.5"L slot(s)
	• 2 PCIe 5.0 x16 AIOM slot(s) (OCP 3.0 compatible)
	M.2: 2 M.2 NVMe/SATA slot(s) (B+M-key 2280/22110)
On-Board Devices	SATA: SATA (6Gbps); RAID 0/1/5/10 support
	NVMe: NVMe; RAID 0/1/5/10 support(Intel® VROC RAID key required)
	Chipset: Intel® C741
	Network Connectivity: Via AIOM
	IPMI: Support for Intelligent Platform Management Interface v.2.0
	IPMI 2.0 with virtual media over LAN and KVM-over-LAN support
Input / Output	LAN: 1 RJ45 1 GbE Dedicated BMC LAN port(s)
Input / Output	LAN: 1 RJ45 1 GbE Dedicated BMC LAN port(s) USB: 2 USB 2.0 port(s) (rear) Video: 1 VGA port(s)







System Cooling	Fans: 4 counter-rotating 80x80x38mm Fan(s) Liquid Cooling: Direct to Chip (D2C) Cold Plate (optional)
Power Supply	2x 1200W Redundant Titanium Level Hot-plug power supplies
System BIOS	BIOS Type: AMI 256MB SPI Flash
Management	SuperCloud Composer; Supermicro Server Manager (SSM); Supermicro Update Manager (SUM); SuperDoctor® 5; Super Diagnostics Offline; TAS: Supermicro Thin-Agent Service (TAS); SAA(new!); IPMICFG; SMCIPMITool; IPMIView
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages, Memory FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors Temperature: Monitoring for CPU and chassis environment Thermal Control for fan connectors
Dimensions and Weight	Weight: Gross Weight: 63 lbs (28.6 kg) Net Weight: 37 lbs (16.8 kg) Available Color: N/A
Operating Environment	Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) Non-operating Temperature: -40°C to 70°C (-40°F to 158°F) Operating Relative Humidity: 8% to 90% (non-condensing) Non-operating Relative Humidity: 5% to 95% (non-condensing)
Motherboard	Super X13DEM
Chassis	CSE-HS829-R1K24P